

#### **Features**

- 1.2kV Schottky Rectifier
- Zero Reverse Recovery Current
- High-Frequency Operation
- Temperature-Independent Switching
- Extremely Fast Switching
- Positive Temperature Coefficient on V<sub>F</sub>
- Increased Creepage/Clearance Distance

#### **Benefits**

- Replace Bipolar with Unipolar Rectifiers
- Essentially No Switching Losses
- Higher Efficiency
- Reduction of Heat Sink Requirements
- Parallel Devices Without Thermal Runaway

### **Applications**

- Switch Mode Power Supplies (SMPS)
- Boost diodes in PFC or DC/DC stages
- Free Wheeling Diodes in Inverter stages
- AC/DC converters





Part Number	Package	Marking
HC4D10120H	TO247-2L	HC4D10120H

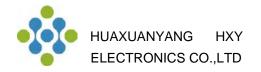
### Maximum Ratings (Tc=25°C unless otherwise specified)

Symbol	Parameter	Value	Unit	Test Conditions	Note
V <sub>RRM</sub>	Repetitive Peak Reverse Voltage	1200	٧		
V <sub>RSM</sub>	Surge Peak Reverse Voltage	1300	٧		
V <sub>R</sub>	DC Peak Reverse Voltage	1200	٧		
I <sub>F</sub>	Continuous Forward Current	31.5 15 10	А	T <sub>c</sub> =25°C T <sub>c</sub> =135°C T <sub>c</sub> =155°C	Fig. 3
$I_{\sf FRM}$	Repetitive Peak Forward Surge Current	46 30	А	$T_c$ =25°C, $t_p$ =10 ms, Half Sine Pulse $T_c$ =110°C, $t_p$ =10 ms, Half Sine Pulse	
I <sub>FSM</sub>	Non-Repetitive Forward Surge Current	67 59	А	$T_c$ =25°C, $t_p$ =10 ms, Half Sine Pulse $T_c$ =110°C, $t_p$ =10 ms, Half Sine Pulse	Fig. 8
I <sub>F,Max</sub>	Non-Repetitive Peak Forward Current	750 620	А	$T_c$ =25°C, $t_p$ =10 $\mu$ s, Pulse $T_c$ =110°C, $t_p$ =10 $\mu$ s, Pulse	Fig. 8
P <sub>tot</sub>	Power Dissipation	153 66	W	T <sub>c</sub> =25°C T <sub>c</sub> =110°C	Fig. 4
dV/dt	Diode dV/dt ruggedness	200	V/ns	V <sub>R</sub> =0-960V	
∫i²dt	i²t value	22.5 17.5	A²s	$T_c = 25^{\circ}C$ , $t_p = 10 \text{ ms}$ $T_c = 110^{\circ}C$ , $t_p = 10 \text{ ms}$	
T <sub>J</sub> , T <sub>stg</sub>	Operating Junction and Storage Temperature	-55 to +175	°C		
	TO-247 Mounting Torque	1 8.8	Nm lbf-in	M3 Screw 6-32 Screw	



T0247-2L **Package** 





#### **Electrical Characteristics**

Symbol	Parameter	Тур.	Max.	Unit	Test Conditions	Note
V <sub>F</sub>	Forward Voltage	1.5 2.2	1.8 3	V	$I_F = 10 \text{ A } T_J = 25^{\circ}\text{C}$ $I_F = 10 \text{ A } T_J = 175^{\circ}\text{C}$	Fig. 1
I <sub>R</sub>	Reverse Current	30 55	250 350	μA	V <sub>R</sub> = 1200 V T <sub>J</sub> =25°C V <sub>R</sub> = 1200 V T <sub>J</sub> =175°C	Fig. 2
Q <sub>c</sub>	Total Capacitive Charge	52		nC	$V_R = 800 \text{ V}, I_F = 10\text{A}$ $di/dt = 200 \text{ A}/\mu\text{s}$ $T_J = 25^{\circ}\text{C}$	Fig. 5
С	Total Capacitance	754 45 38		pF	$V_R = 0 \text{ V, } T_J = 25^{\circ}\text{C, } f = 1 \text{ MHz}$ $V_R = 400 \text{ V, } T_J = 25^{\circ}\text{C, } f = 1 \text{ MHz}$ $V_R = 800 \text{ V, } T_J = 25^{\circ}\text{C, } f = 1 \text{ MHz}$	Fig. 6
E <sub>c</sub>	Capacitance Stored Energy	14.5		μJ	V <sub>R</sub> = 800 V	Fig. 7

Note: This is a majority carrier diode, so there is no reverse recovery charge.

### **Thermal Characteristics**

Symbol	mbol Parameter		Unit	Note
$R_{_{\theta JC}}$	Thermal Resistance from Junction to Case	0.98	°C/W	Fig. 9

## **Typical Performance**

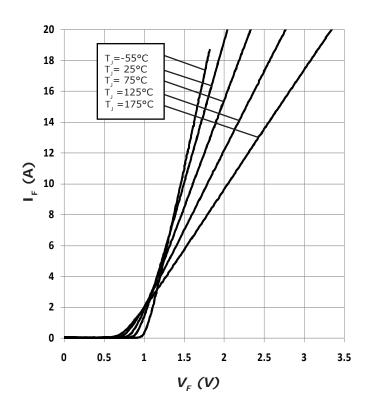


Figure 1. Forward Characteristics

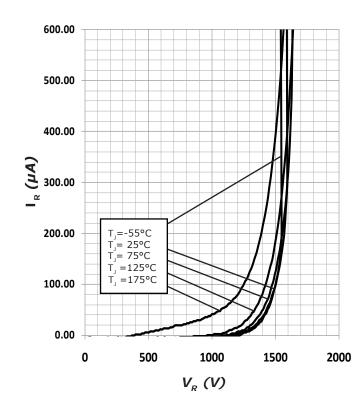
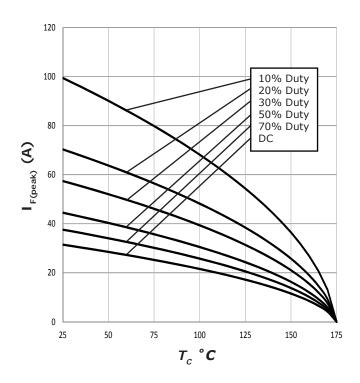


Figure 2. Reverse Characteristics

## **Typical Performance**



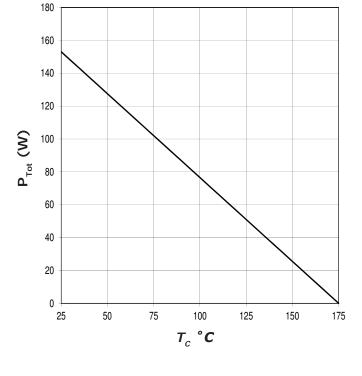


Figure 3. Current Derating

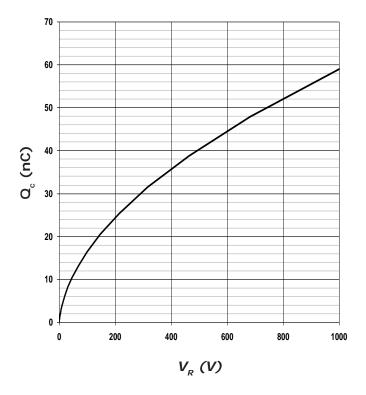


Figure 5. Recovery Charge vs. Reverse Voltage

Figure 4. Power Derating

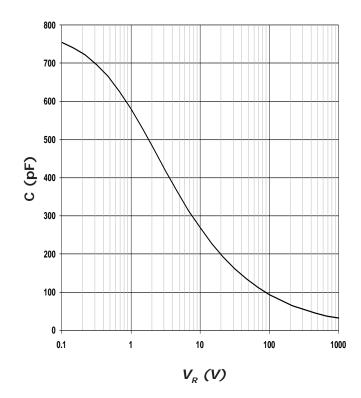
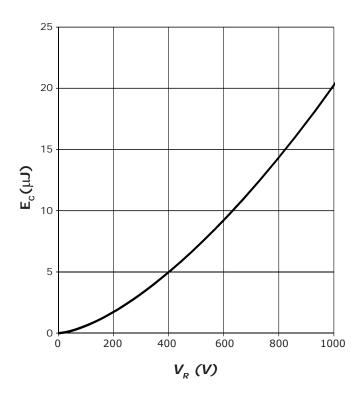


Figure 6. Capacitance vs. Reverse Voltage



## **Typical Performance**



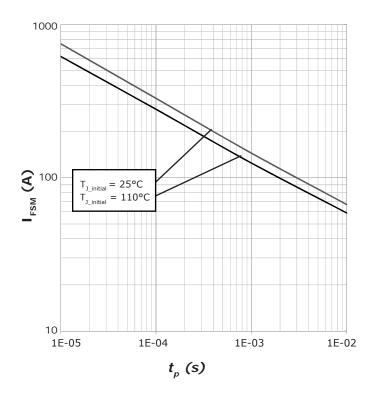


Figure 7. Typical Capacitance Stored Energy

Figure 8. Non-repetitive peak forward surge current versus pulse duration (sinusoidal waveform)

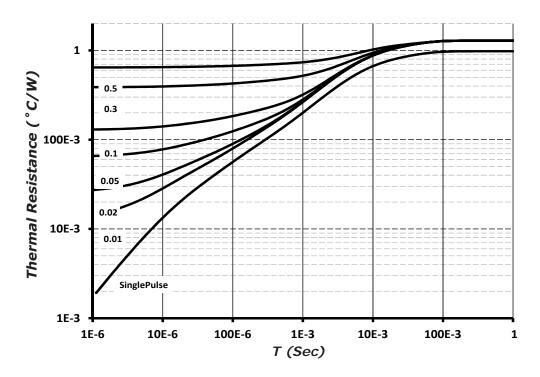


Figure 9. Transient Thermal Impedance

### **Diode Model**

$$V_{T}$$

$$V_{fT} = V_T + If * R_T$$

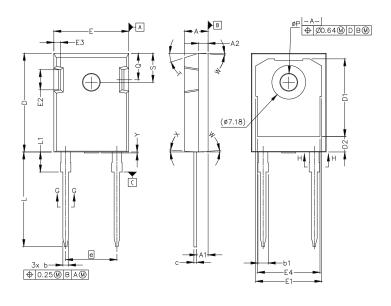
$$V_T = 0.98 + (T_J^* - 1.71^*10^{-3})$$
  
 $R_T = 0.040 + (T_J^* 5.32^*10^{-4})$ 

Note:  $T_j$  = Diode Junction Temperature In Degrees Celsius, valid from 25°C to 175°C



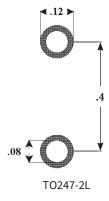
# **Package Dimensions**

Package: TO247-2L All dimensions in mm.



0.04	MILLIMETERS		INCHES			
SYM	MIN	MAX	MIN	MAX		
A	4.83	5.21	.190	.205		
A1	2.29	2.54	.090	.100		
A2	1.91	2.16	.075	.085		
b'	1.07	1.28	.042	.050		
b	1.07	1.33	.042	.052		
bl	1.91	2.41	.075	.095		
b2	1.91	2.16	.075	.085		
c'	0.55	0.65	.022	.026		
С	0.55	0.68	.022	.027		
D	20.80	21.10	.819	.831		
D1	16.25	17.35	.640	.683		
D2	2.86	3.16	.112	.124		
Е	15.75	16.13	.620	.635		
E1	13.10	14.15	.516	.557		
E2	3.68	5.10	.145	.201		
E3	1.00	1.90	.039	.075		
E4	12.38	13.43	.487	.529		
e	10.88	BSC	.4281	BSC		
L	19.81	20.32	.780	.800		
L1	4.10	4.40	.161	.173		
φP	3.51	3.65	.138	.144		
Q	5.49	6.00	.216	.236		
S	6.04	6.30	.238	.248		
T		17.5° REF.				
W		3.5° REF.				
X		4° REF.				
Y	0	0.50	0	0.020		

# **Recommended Solder Pad Layout**



all units are in inches

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